



SamHop Microelectronics Corp.

**STB/P454**

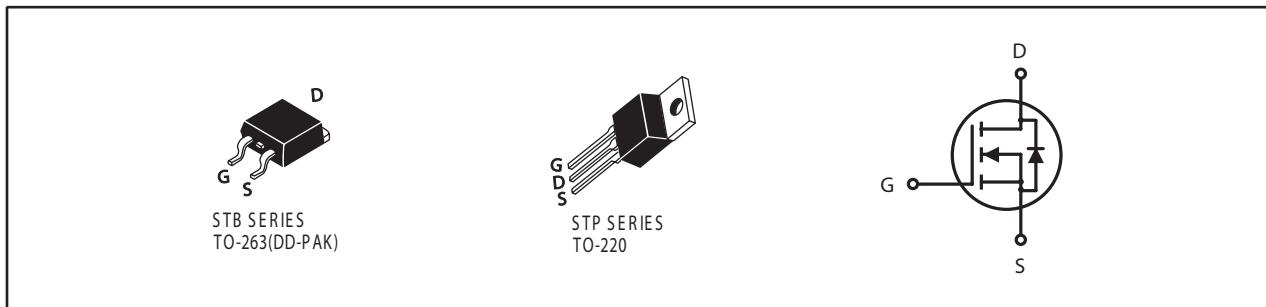
Ver 1.1

N-Channel Logic Level Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
40V	80A	4.8 @ VGS=10V
		7.2 @ VGS=4.5V

FEATURES

- Super high dense cell design for extremely low RDS(ON).
- High power and current handling capability.
- TO-220 & TO-263 package.



ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Units
V_{DS}	Drain-Source Voltage	40	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current-Continuous ^a	$T_C=25^\circ\text{C}$	A
		$T_C=70^\circ\text{C}$	A
I_{DM}	-Pulsed ^a	235	A
E_{AS}	Avalanche Energy ^c	462	mJ
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	W
		$T_C=70^\circ\text{C}$	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to 175	°C

THERMAL CHARACTERISTICS

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

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ELECTRICAL CHARACTERISTICS (T_c=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =32V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Body leakage current	V _{GS} = ±20V , V _{DS} =0V			±100	nA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	2	3	V
R _{D(S(ON))}	Drain-Source On-State Resistance	V _{GS} =10V , I _D =40A		3.6	4.8	m ohm
		V _{GS} =4.5V , I _D =31A		5.3	7.2	m ohm
g _{FS}	Forward Transconductance	V _{DS} =20V , I _D =40A		111		S
DYNAMIC CHARACTERISTICS ^b						
C _{ISS}	Input Capacitance	V _{DS} =20V,V _{GS} =0V f=1.0MHz		3750		pF
C _{OSS}	Output Capacitance			590		pF
C _{RSS}	Reverse Transfer Capacitance			500		pF
SWITCHING CHARACTERISTICS ^b						
t _{D(ON)}	Turn-On DelayTime	V _{DD} =20V I _D =1A V _{GS} =10V R _{GEN} = 6 ohm		70		ns
t _r	Rise Time			103		ns
t _{D(OFF)}	Turn-Off DelayTime			170		ns
t _f	Fall Time			75		ns
Q _g	Total Gate Charge	V _{DS} =20V,I _D =25A,V _{GS} =10V		67		nC
		V _{DS} =20V,I _D =25A,V _{GS} =4.5V		33		nC
Q _{gs}	Gate-Source Charge	V _{DS} =20V,I _D =25A, V _{GS} =10V		5.2		nC
Q _{gd}	Gate-Drain Charge			22		nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
V _{SD}	Diode Forward Voltage	V _{GS} =0V,I _S =10A		0.79	1.3	V

Notes

- a.Drain current limited by maximum junction temperature.
- b.Guaranteed by design, not subject to production testing.
- c.Starting T_J=25°C,L=0.5mH,V_{DD} = 20V.(See Figure13)

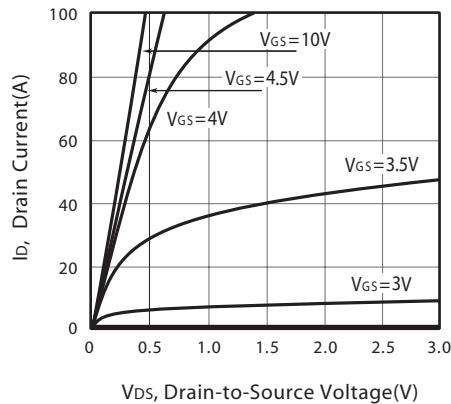


Figure 1. Output Characteristics

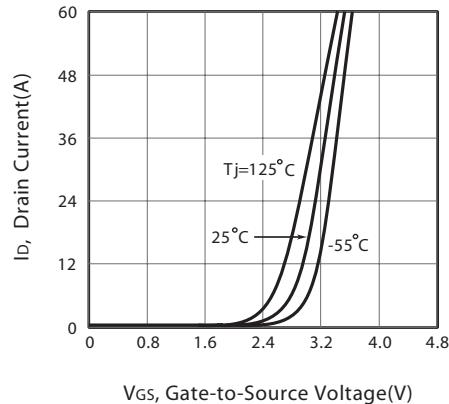


Figure 2. Transfer Characteristics

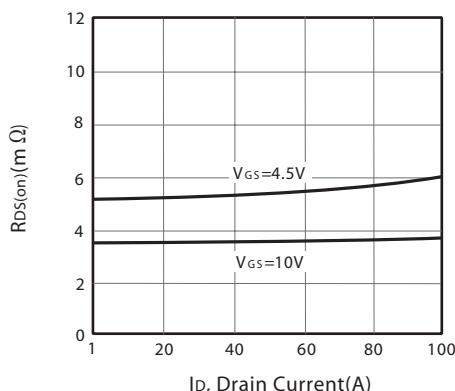


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

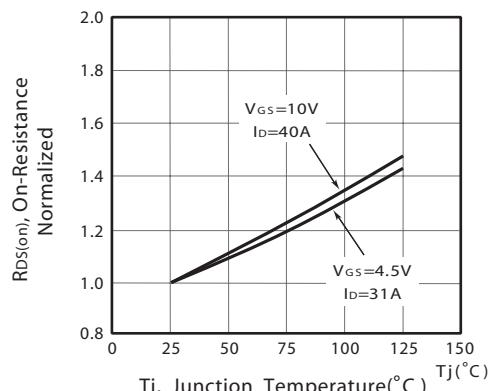


Figure 4. On-Resistance Variation with Drain Current and Temperature

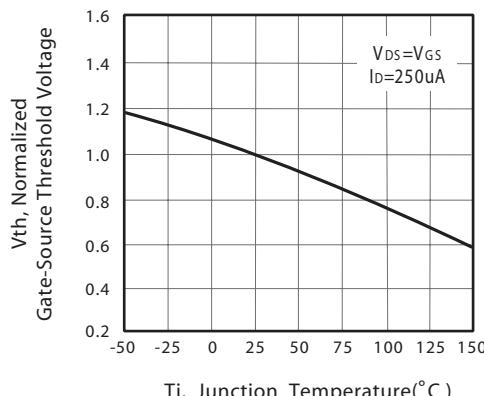


Figure 5. Gate Threshold Variation with Temperature

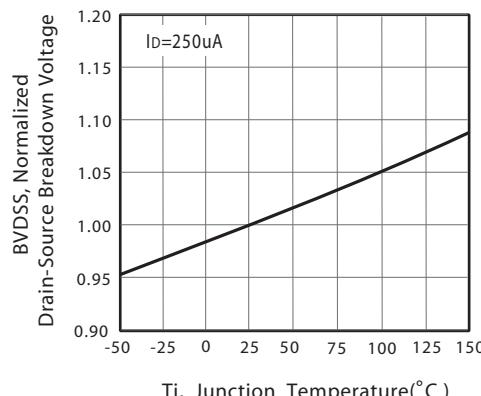
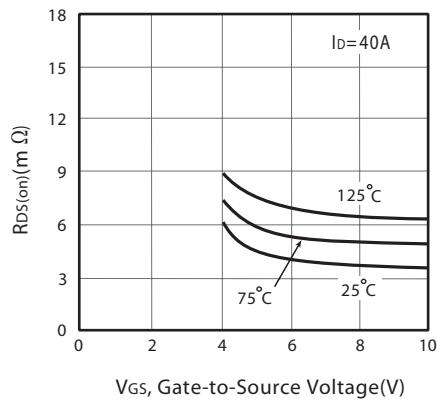


Figure 6. Breakdown Voltage Variation with Temperature

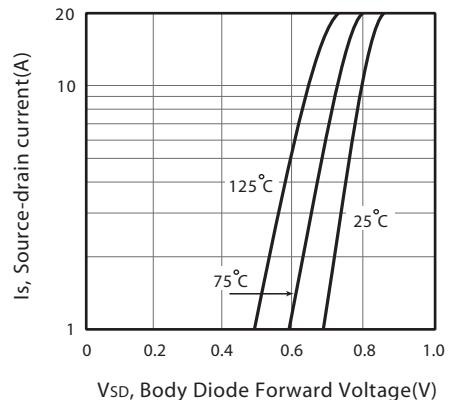
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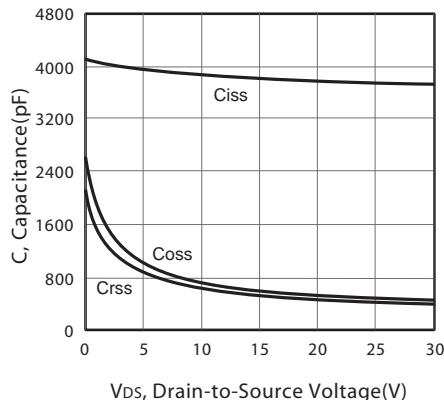
V_{GS}, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs. Gate-Source Voltage



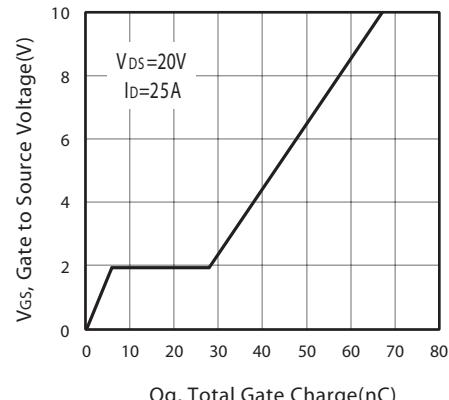
V_{SD}, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



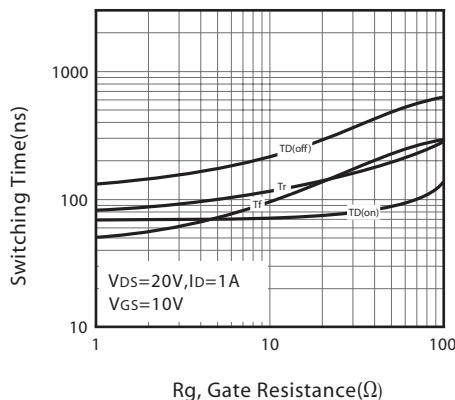
V_{DS}, Drain-to-Source Voltage(V)

Figure 9. Capacitance



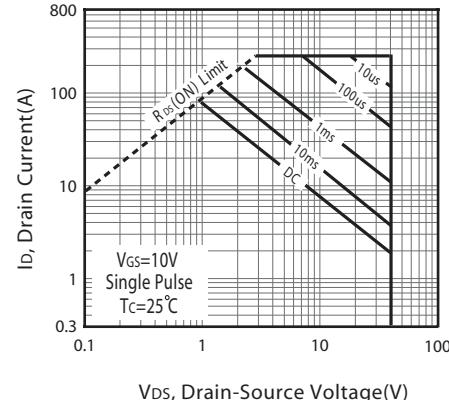
Q_g, Total Gate Charge(nC)

Figure 10. Gate Charge



R_g, Gate Resistance(Ω)

Figure 11. switching characteristics

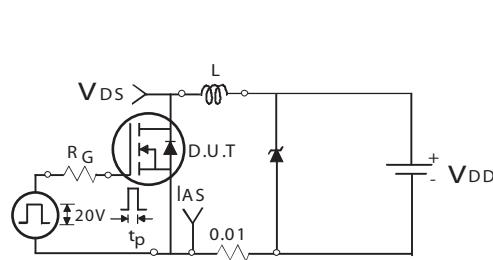


V_{DS}, Drain-Source Voltage(V)

Figure 12. Maximum Safe Operating Area

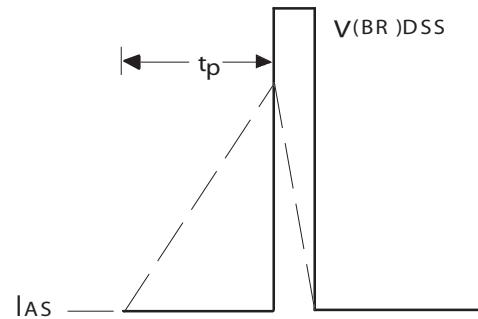
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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

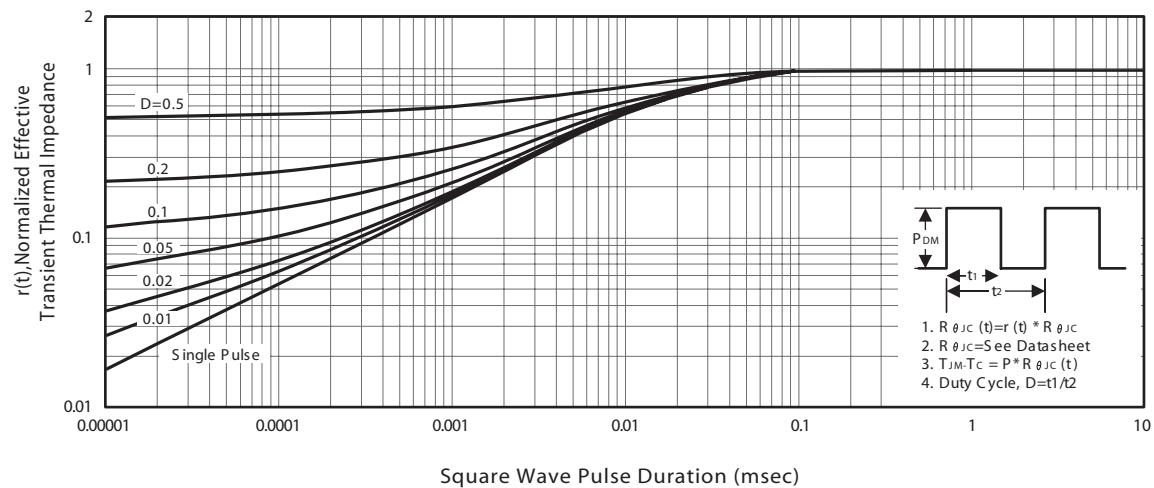
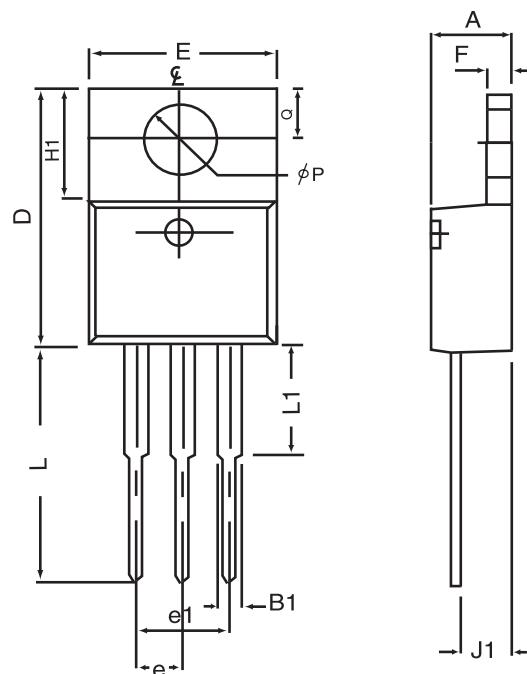


Figure 14. Normalized Thermal Transient Impedance Curve

PACKAGE OUTLINE DIMENSIONS

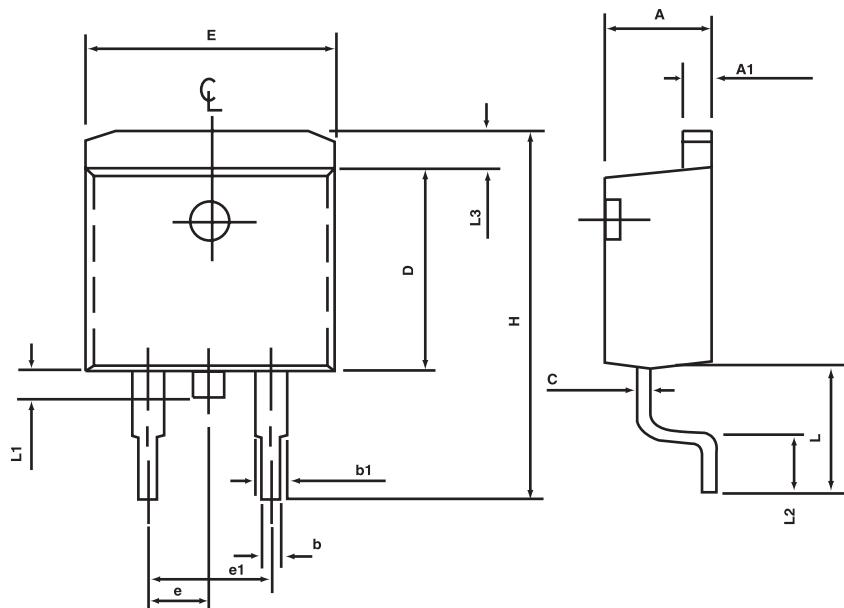
TO-220



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.32	4.80	0.170	0.189
B1	1.27	1.65	0.050	0.630
D	14.6	16.00	0.575	0.610
E	9.70	10.41	0.382	0.410
e	2.34	2.74	0.092	0.108
e1	4.68	5.48	0.184	0.216
F	1.14	1.40	0.045	0.055
H1	5.97	6.73	0.235	0.265
J1	2.20	2.79	0.087	0.110
L	12.88	14.22	0.507	0.560
L1	3.00	6.35	0.120	0.250
φP	3.50	3.94	0.138	0.155
Q	2.54	3.05	0.100	0.120

PACKAGE OUTLINE DIMENSIONS

TO-263AB



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.70	0.169	0.185
A1	1.22	1.32	0.048	0.055
b	0.69	0.94	0.027	0.037
b1	1.22	1.40	0.048	0.055
C	0.36	0.56	0.014	0.022
D	8.64	9.652	0.340	0.380
E	9.70	10.54	0.382	0.415
e	2.29	2.79	0.090	0.110
e1	4.83	5.33	0.190	0.210
H	14.60	15.78	0.575	0.625
L	4.70	5.84	0.185	0.230
L1	1.20	1.778	0.047	0.070
L2	2.24	2.84	0.088	0.111
L3	1.40 MAX		0.055 MAX	

TO-220/263AB Tube

